

FEATURES:

- N channel FET switches with no parasitic diode to Vcc
 - Isolation under power-off conditions
 - No DC path to Vcc or GND
 - 5V tolerant in OFF and ON state
- 5V tolerant I/Os
- Flat Ron characteristics over operating range
- Rail-to-rail switching 0 - 5V
- Bidirectional dataflow with near-zero delay: no added ground bounce
- Excellent Ron matching between channels
- Vcc operation: 2.3V to 3.6V
- High bandwidth
- LVTTL-compatible control Inputs
- Undershoot Clamp Diodes on all switch and control Inputs
- Low I/O capacitance, 4pF typical
- 25Ω resistors for low noise and line matching
- Available in QSOP and TSSOP packages

DESCRIPTION:

The QS3VH2862 HotSwitch is a high bandwidth bus switch with 10-bit active high and low enable. The QS3VH2862, with 25Ω ON resistance and 1.35ns propagation delay, is ideal for line matching and low noise environments. The switches are controlled by independent active low enable (\overline{BE}) and active high enable (BE) control. In the ON state, the switches can pass signals up to 5V. In the OFF state, the switches offer very high impedance at the terminals.

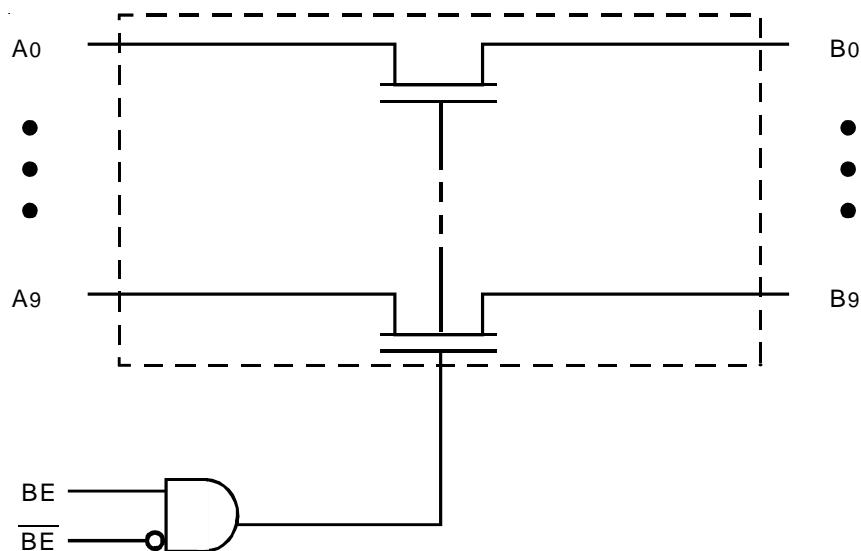
The combination of small propagation delay, high OFF impedance, and over-voltage tolerance makes the QS3VH2862 ideal for high performance communication applications.

The QS3VH2862 is characterized for operation from -40°C to +85°C.

APPLICATIONS:

- Hot-swapping
- Low distortion analog switch
- Replaces mechanical relay
- ATM 25/155 switching

FUNCTIONAL BLOCK DIAGRAM

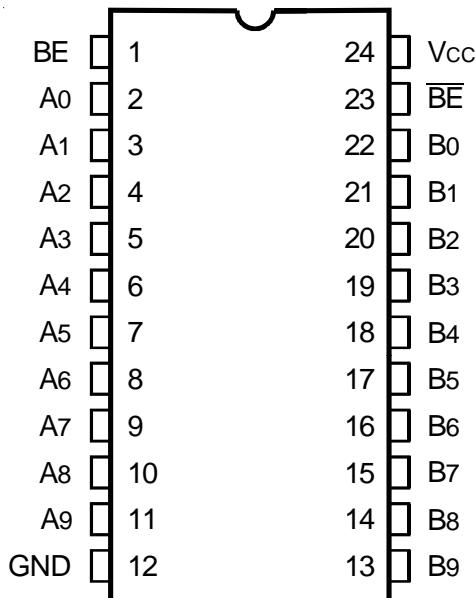


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INDUSTRIAL TEMPERATURE RANGE

AUGUST 2002

PIN CONFIGURATION

QSOP/TSSOP
TOP VIEWABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max	Unit
VTERM ⁽²⁾	Supply Voltage to Ground	-0.5 to +4.6	V
VTERM ⁽³⁾	DC Switch Voltage Vs	-0.5 to +5.5	V
VTERM ⁽³⁾	DC Input Voltage Vin	-0.5 to +5.5	V
VAC	AC Input Voltage (pulse width \leq 20ns)	-3	V
IOUT	DC Output Current (max. sink current/pin)	120	mA
TSTG	Storage Temperature	-65 to +150	°C

NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- Vcc terminals.
- All terminals except Vcc .

CAPACITANCE ($T_A = +25^\circ\text{C}$, $f = 1\text{MHz}$, $V_{IN} = 0\text{V}$, $V_{OUT} = 0\text{V}$)

Symbol	Parameter ⁽¹⁾	Typ.	Max.	Unit
C _{IN}	Control Inputs	3	5	pF
C _{I/O}	Quickswitch Channels (Switch OFF)	4	6	pF
C _{I/O}	Quickswitch Channels (Switch ON)	8	12	pF

NOTE:

- This parameter is guaranteed but not production tested.

PIN DESCRIPTION

Pin Names	Description
BE	Active HIGH Bus Enable
\overline{BE}	Active LOW Bus Enable
A ₀ - A ₉	Bus A
B ₀ - B ₉	Bus B

FUNCTION TABLE⁽¹⁾

BE	\overline{BE}	A ₀ - A ₉	Function
L	L	Z	Disconnect
L	H	Z	Disconnect
H	L	B ₀ - B ₉	Connect
H	H	Z	Disconnect

NOTE:

- H = HIGH Voltage Level
- L = LOW Voltage Level
- Z = High-Impedance

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

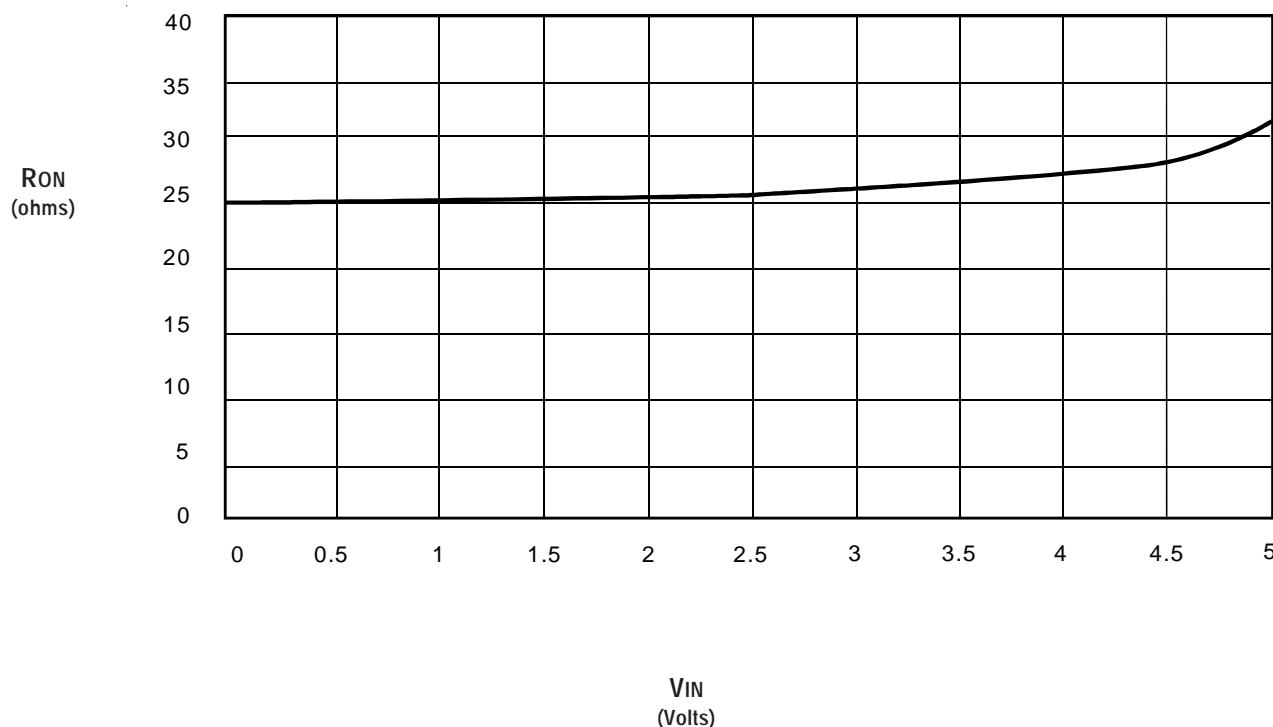
Industrial: TA = -40°C to +85°C, VCC = 3.3V ±0.3V

Symbol	Parameter	Test Conditions			Min.	Typ. ⁽¹⁾	Max.	Unit
VIH	Input HIGH Voltage	Guaranteed Logic HIGH for Control Inputs	VCC = 2.3V to 2.7V		1.7	—	—	V
			VCC = 2.7V to 3.6V		2	—	—	
VIL	Input LOW Voltage	Guaranteed Logic LOW for Control Inputs	VCC = 2.3V to 2.7V		—	—	0.7	V
			VCC = 2.7V to 3.6V		—	—	0.8	
IIN	Input Leakage Current (Control Inputs)	0V ≤ VIN ≤ VCC			—	—	±1	µA
IOZ	Off-State Current (Hi-Z)	0V ≤ VOUT ≤ 5V, Switches OFF			—	—	±1	µA
IOFF	Data Input/Output Power Off Leakage	VIN or VOUT 0V to 5V, VCC = 0V			—	—	±1	µA
RON	Switch ON Resistance	VCC = 2.3V Typical at VCC = 2.5V	VIN = 0V	I _{ON} = 30mA	18	27	39	Ω
			VIN = 1.7V	I _{ON} = 15mA	18	28	41	
		VCC = 3V	VIN = 0V	I _{ON} = 30mA	18	25	38	
			VIN = 2.4V	I _{ON} = 15mA	18	26	40	

NOTE:

1. Typical values are at VCC = 3.3V and TA = 25°C.

TYPICAL ON RESISTANCE vs VIN AT VCC = 3.3V

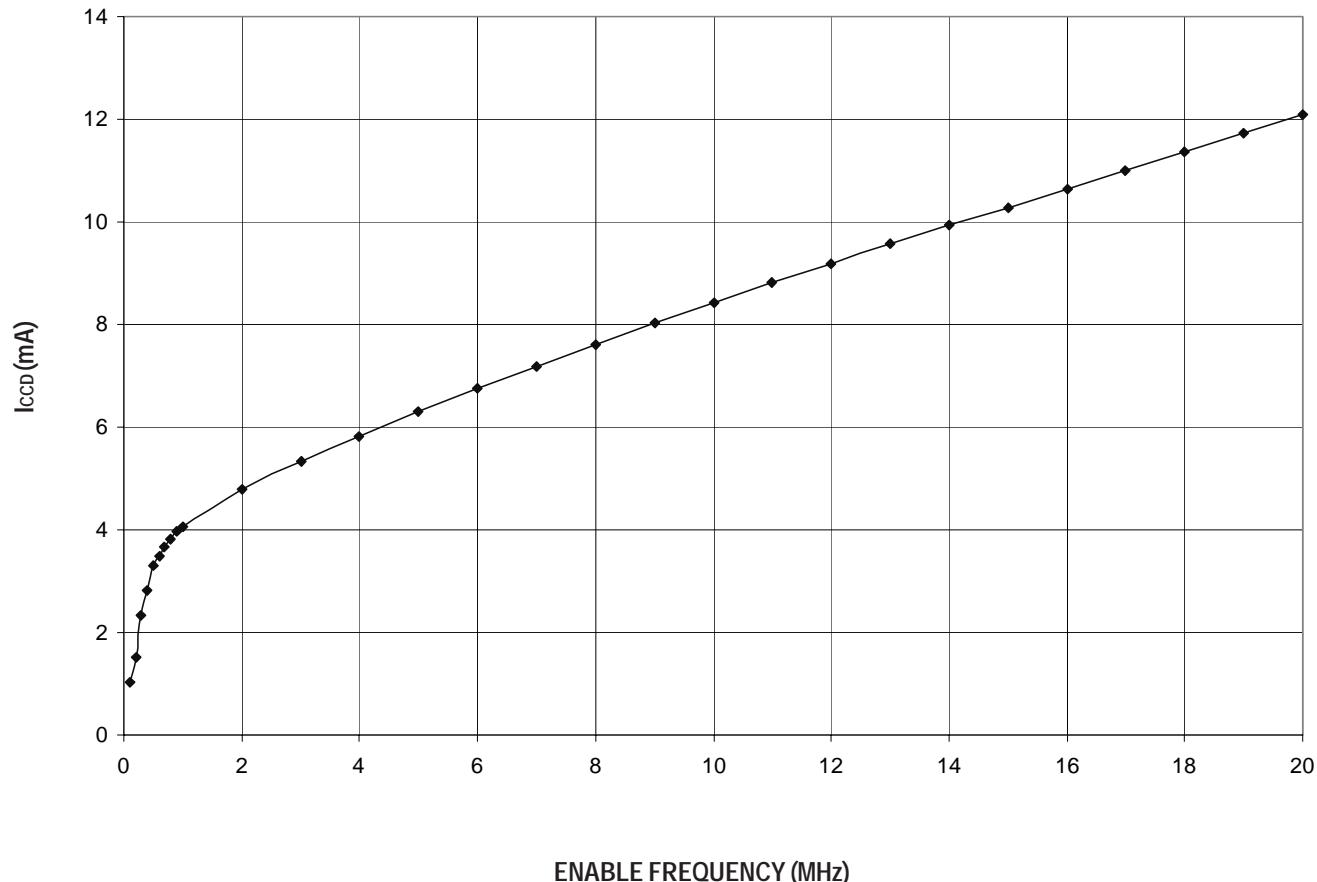


POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾	Min.	Typ.	Max.	Unit
I _{CCQ}	Quiescent Power Supply Current	V _{CC} = Max., V _{IN} = GND or V _{CC} , f = 0	—	1	4	mA
ΔI _{CC}	Power Supply Current ^(2,3) per Input HIGH	V _{CC} = Max., V _{IN} = 3V, f = 0 per Control Input	—	—	30	μA
I _{CCD}	Dynamic Power Supply Current ⁽⁴⁾	V _{CC} = 3.3V, A and B Pins Open, Control Inputs Toggling @ 50% Duty Cycle	See Typical I _{CCD} vs Enable Frequency graph below			

NOTES:

1. For conditions shown as Min. or Max., use the appropriate values specified under DC Electrical Characteristics.
2. Per input driven at the specified level. A and B pins do not contribute to ΔI_{CC}.
3. This parameter is guaranteed but not tested.
4. This parameter represents the current required to switch internal capacitance at the specified frequency. The A and B inputs do not contribute to the Dynamic Power Supply Current. This parameter is guaranteed but not production tested.

TYPICAL I_{CCD} VS ENABLE FREQUENCY CURVE AT V_{CC} = 3.3V

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

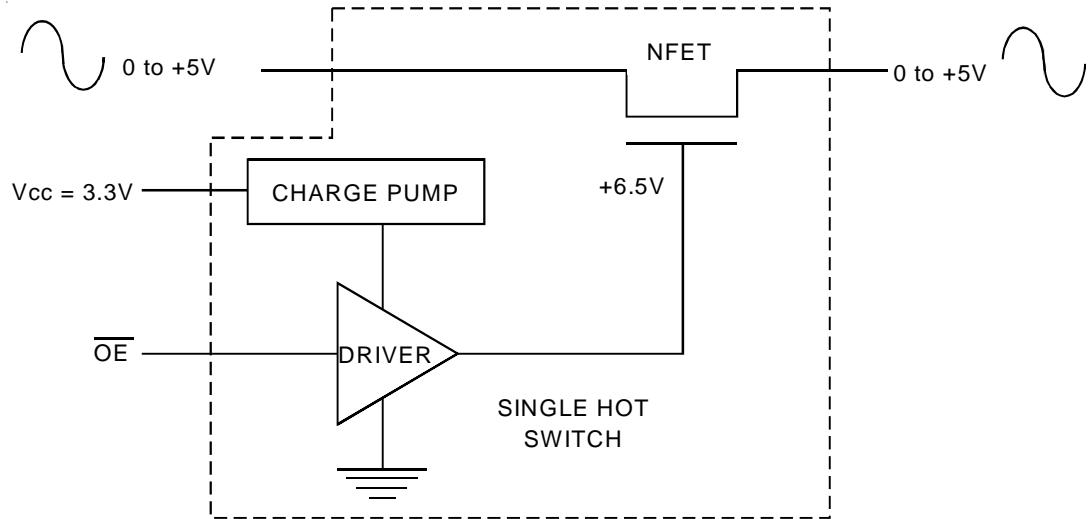
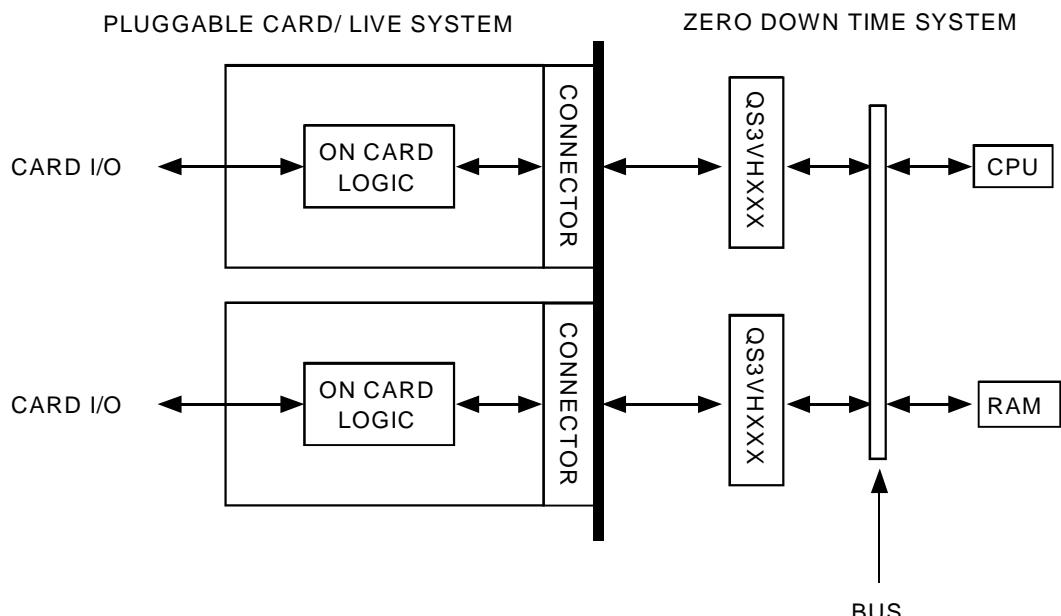
 $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$

Symbol	Parameter	$V_{CC} = 2.5 \pm 0.2\text{V}^{(1)}$		$V_{CC} = 3.3 \pm 0.3\text{V}^{(1)}$		Unit
		Min. ⁽⁴⁾	Max.	Min. ⁽⁴⁾	Max.	
t_{PLH}	Data Propagation Delay ^(2,3) A_x to B_x or B_x to A_x	—	0.9	—	1.35	ns
t_{PZL}	Switch Turn-On Delay \bar{BE} or BE to A_x or B_x	1.5	9	1.5	8	ns
t_{PLZ}	Switch Turn-Off Delay \bar{BE} or BE to A_x or B_x	1.5	7.5	1.5	7.5	ns
$f_{BE\text{or}BE}$	Operating Frequency-Enable ^(2,5)	—	10	—	20	MHz

NOTES:

1. See Test Conditions under TEST CIRCUITS AND WAVEFORMS.
2. This parameter is guaranteed but not production tested.
3. The bus switch contributes no propagation delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 1.35ns at $C_L = 50\text{pF}$. Since this time constant is much smaller than the rise and fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.
4. Minimums are guaranteed but not production tested.
5. Maximum toggle frequency for \bar{BE} or BE control input (pass voltage > V_{CC} , $V_{IN} = 5\text{V}$, $R_{LOAD} \geq 1\text{M}\Omega$, no C_{LOAD}).

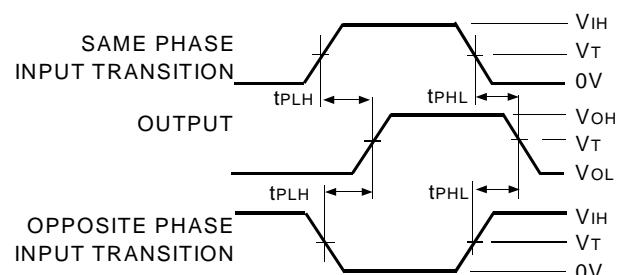
SOME APPLICATIONS FOR HOTSWITCH PRODUCTS

*Rail-to-Rail Switching**Hot-Swapping*

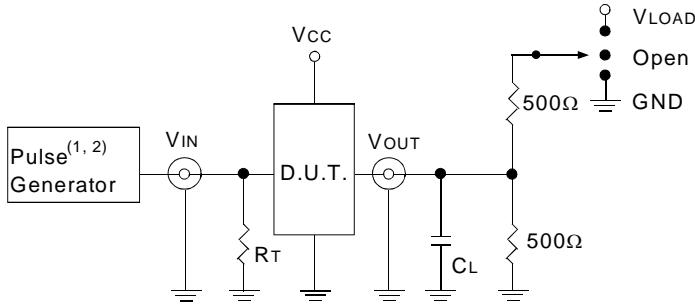
TEST CIRCUITS AND WAVEFORMS

TEST CONDITIONS

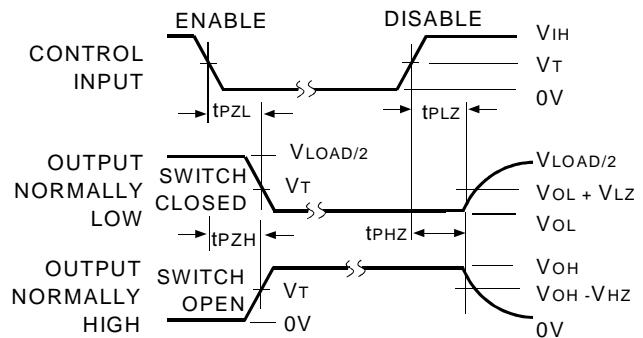
Symbol	$V_{CC}^{(1)} = 3.3V \pm 0.3V$	$V_{CC}^{(2)} = 2.5V \pm 0.2V$	Unit
V_{LOAD}	6	$2 \times V_{CC}$	V
V_{IH}	3	V_{CC}	V
V_T	1.5	$V_{CC}/2$	V
V_{LZ}	300	150	mV
V_{HZ}	300	150	mV
C_L	50	30	pF



Propagation Delay



Test Circuits for All Outputs



NOTE:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

Enable and Disable Times

DEFINITIONS:

C_L = Load capacitance: includes jig and probe capacitance.

R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator.

NOTES:

1. Pulse Generator for All Pulses: Rate $\leq 10MHz$; $t_f \leq 2.5ns$; $t_r \leq 2.5ns$.
2. Pulse Generator for All Pulses: Rate $\leq 10MHz$; $t_f \leq 2ns$; $t_r \leq 2ns$.

SWITCH POSITION

Test	Switch
t_{PLZ}/t_{PZL}	V_{LOAD}
t_{PHZ}/t_{PZH}	GND
t_{PD}	Open

ORDERING INFORMATION

IDTQS XXXXX XX
Device Type Package

		Q	Quarter Size Outline Package
		PA	Thin Shrink Small Outline Package
	3VH2862		2.5V / 3.3V 10-Bit Active High and Low Enable, High Bandwidth Switch

DATA SHEET DOCUMENT HISTORY

8/6/2002 Updated according to PCN Logic-0206-11



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